

Low-noise, 1.2 A transformer driver for isolated power supplies Rev. 1 — 28 June 2024 Short da

Short data sheet

### 1. General description

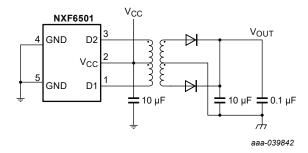
The NXF6501-Q100 is a specialized push-pull transformer driver that is designed to deliver low noise and low EMI for isolated power supplies in small form factors. This driver is capable of driving low-profile, center-tapped transformers from a 2.25 V to 5 V DC power supply, while achieving ultra-low noise and EMI through the use of slew rate control and Spread Spectrum Clocking (SSC).

The NXF6501-Q100 comprises an oscillator and a gate drive circuit that produces complementary output signals to drive ground-referenced N-channel power switches. To ensure start-up under heavy loads, the device includes two 1.2 A power-MOSFET switches.

The NXF6501-Q100 also features internal protection features such as current limiting, under-voltage lockout, thermal shutdown, and break-before-make circuitry, ensuring the device operates within safe limits. The device also includes a soft-start feature that prevents high inrush current during power-up with large load capacitors.

The NXF6501-Q100 has a 440 kHz internal oscillator for applications that require higher efficiency and smaller transformer. The NXF6501-Q100 is available in a small 5 pin SOT8098-1 package and is characterized for operation within a temperature range of -55 °C to 125 °C.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.



### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -55 °C to +125 °C
- Push-pull driver for transformers
- Wide input voltage range: 2.25 V to 5.5 V
- High output drive: 1.2 A at 5 V supply
- Low R<sub>ON</sub> 0.2 Ω maximum at 5 V supply
- Optimized for low EMI
- Spread Spectrum Clocking (SSC)
- Internal switching frequency: 440 kHz
- Slew-rate control
- 1.7 A current limit
- Thermal shutdown
- Small 5 pin SOT8098-1 package
- Soft-start to reduce In-rush current
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3A
    exceeds 6000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1500 V

### 3. Applications

- Isolated power supply for CAN, RS-485, RS-422, RS-232, SPI, I<sup>2</sup>C, low-power LAN
- Low-noise isolated USB supplies
- Process control
- Telecom supplies
- Radio supplies
- · Distributed supplies
- Medical instruments
- Precision instruments
- · Low-noise filament supplies
- Isolated power supplies for automotive (AEC-Q100)
  - Traction inverter and motor control
  - DC-DC converter
  - Battery management system
  - On-board charger

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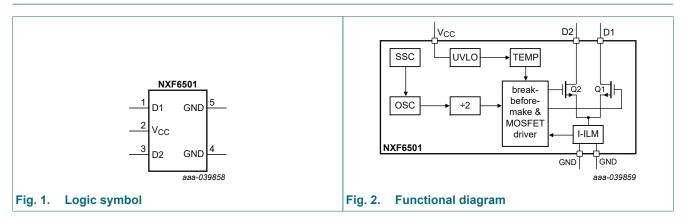
### 4. Ordering information

Table 1. Ordering information    Type number  Package							
	Temperature range	Name	Description	Version			
NXF6501DC-Q100	-55 °C to +125 °C	TSSOP5	plastic, surface-mounted package; 5 terminals; 0.95 mm pitch; 2.9 mm × 1.6 mm × 1.1 mm body	<u>SOT8098-1</u>			

### 5. Marking

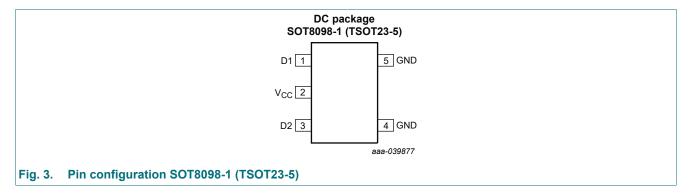
Table 2. Marking						
Type number	Marking code					
NXF6501DC-Q100	01					

### 6. Functional diagram



### 7. Pinning information

#### 7.1. Pinning information



#### 7.2. Pin description

Symbol	Pin	Туре	Description
D1	1	0	Open-drain output of the first power MOSFETs. Usually connected to one of the outer terminals of the center tap transformer. Because large currents flow through this pin, its external trace should be kept short.
V <sub>CC</sub>	2	Р	This is the device supply pin. It should be bypassed with a 4.7 $\mu$ F or greater, low ESR capacitor. When V <sub>CC</sub> ≤ 2.25 V, an internal undervoltage lockout circuit trips and turns both outputs off.
D2	3	0	Open-drain output of the second power MOSFETs. Usually connected to the other one of the outer terminals of the center tap transformer. Because large currents flow through this pin, its external trace should be kept short.
GND	4, 5	G	GND is connected to the source of the power MOSFET switches via an internal sense circuit. Because large currents flow through it, the GND terminals must be connected to a low- inductance quality ground plane.

### 8. Functional description

#### 8.1. Overview

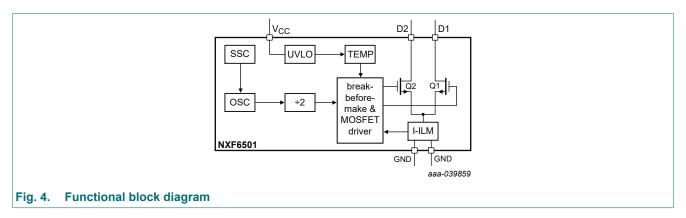
The NXF6501-Q100 is a specialized transformer driver designed to cater to low-cost, small form-factor, and isolated DC-DC converters. It utilizes push-pull topology to provide efficient power conversion to such systems. The device includes an oscillator that provides a signal to a gate-drive circuit, which generates two complementary output signals that control the switching of two output transistors alternatively.

The gate-drive circuit consists of a frequency divider and a break-before-make  $(t_{b-m})$  logic, which work together to ensure the efficient and safe operation of the device. The frequency divider divides the output frequency of the oscillator by two, allowing the device to operate at a frequency that is appropriate for its intended use.

The break-before-make logic inserts a dead-time between the high-pulses of the two signals, ensuring that both transistors are not turned on simultaneously, which could result in a short circuit. Before either of the gates can assume a logic high, the break-before-make logic ensures a short period of time during which both signals are low, and both transistors are in a high-impedance state. This short period is crucial to prevent shorting out both ends of the primary, which can damage the device or cause it to malfunction.

#### 8.2. Functional block diagram

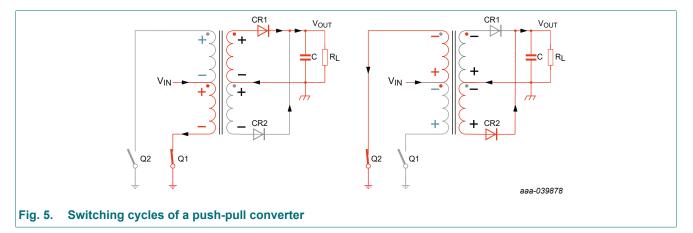
The NXF6501-Q100 functional block diagram is shown below:



#### 8.3. Feature description

#### **Push-pull converter**

A push-pull converter is a type of DC-DC converter that uses a transformer with a center-tap to transfer power from the primary to the secondary. The converter uses two switches, Q1 and Q2, to alternately switch current through the two halves of the transformer primary. (see Fig. 5 below).



When Q1 conducts, it drives a current through the lower half of the primary to ground, creating a negative voltage potential at the lower primary end with respect to the  $V_{IN}$  potential at the center-tap. At the same time, the voltage across the upper half of the primary is such that the upper primary end is positive with respect to the center-tap in order to maintain the previously established current flow through Q2, which is now in a high-impedance state.

The two voltage sources, each equaling  $V_{IN}$ , appear in series and cause a voltage potential at the open end of the primary of  $2 \times V_{IN}$  with respect to ground. Per dot convention, the same voltage polarities that occur at the primary also occur at the secondary. The positive potential of the upper secondary end therefore forward biases diode CR1. The secondary current starting from the upper secondary end flows through CR1, charges capacitor C, and returns through the load impedance  $R_L$  back to the center-tap.

During the off-time of Q1, Q2 conducts, and the current flow in the primary is reversed. This creates a negative voltage potential at the upper primary end with respect to the center-tap, and a positive voltage potential at the lower primary end. The same voltage polarities occur at the secondary, and the lower secondary end is now forward biased, causing the secondary current to flow through CR2, charging capacitor C, and returning through the load impedance  $R_L$  back to the center-tap.

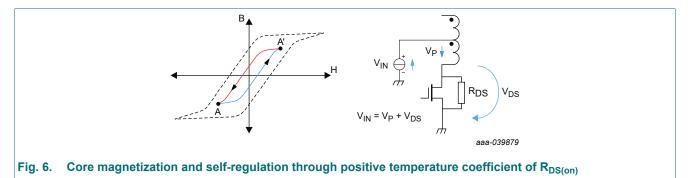
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By alternately switching current through the two halves of the transformer primary, the push-pull converter can step up or step down the input voltage to the desired output voltage. The capacitor C acts as a filter, smoothing out the output voltage ripple.

During the operation of a push-pull converter, when Q2 conducts, Q1 turns off and the voltage polarities at both primary and secondary sides of the transformer reverse. The lower end of the primary now presents an open end with a voltage potential of  $2 \times V_{IN}$  against ground. Consequently, diode CR2 becomes forward biased, while diode CR1 becomes reverse biased. As a result, the current flows from the lower end of the secondary through CR2, charges the capacitor, and then returns through the load impedance R<sub>L</sub> to the center-tap of the transformer. This completes one cycle of operation of the push-pull converter, and the process repeats for subsequent cycles.

#### **Core magnetization**

Fig. 6 depicts the magnetizing curve for an ideal push-pull converter, where B and H represent magnetic flux density and field strength, respectively. During Q1 conduction, the magnetic flux moves from point A to A', and during Q2 conduction, it moves back to point A. The difference in flux density is proportional to the product of the primary voltage, V<sub>P</sub>, and the on-time, t<sub>ON</sub>. This V-t product determines the core magnetization during each switching cycle. Any imbalance in the V-t products of both phases causes an offset from the B-H curve's origin, leading the transformer towards saturation gradually. It is necessary to maintain balance in push-pull converters for optimal efficiency and reliability, which can be achieved by adjusting the primary voltage, duty cycle, or using a larger core transformer. By carefully designing and selecting the transformer and its components, reliable and efficient operation can be ensured over a wide range of load conditions.



#### 8.4. Functional modes

#### Start-up mode

The internal oscillator of a circuit initiates operation when the supply voltage at  $V_{CC}$  ramps up to 2.25 V. The output stage then starts switching, but the amplitude of the drain signals at D1 and D2 is not yet at its maximum level.

#### Soft-Start mode

The NXF6501-Q100 device is designed to support the soft-start feature. When the power is turned on or the EN pin changes from Low to High, the gate drive of the output power-MOSFET gradually increases from 0 V to  $V_{CC}$  over a period of time. This gradual increase in gate drive prevents high inrush current from  $V_{CC}$  while charging large secondary side decoupling capacitors. It also prevents overshoot in secondary voltage during power-up. Soft-start is an essential feature for power supplies to ensure reliable and stable operation. By gradually increasing the gate drive, the circuit can avoid sudden current spikes that may damage the MOSFET or other components in the circuit. Moreover, the soft-start feature prevents overshoot in secondary voltage, which could cause damage to sensitive components connected to the power supply. The NXF6501-Q100 device is well-suited for applications that require soft start, making them an ideal choice for power supply designs where reliability and stability are critical factors.

#### **Operating mode**

When the device supply has reached its nominal value  $\pm 10$  % the oscillator is fully operating. However, variations over supply voltage and operating temperature can vary the switching frequencies at D1 and D2.

NXF6501\_Q100\_SDS

#### **Disable mode**

To conserve power when not in use, the device includes an enable pin that can be utilized to place the device into an ultralow-power state. The enable pin comes equipped with an internal pull-down resistor that automatically disables the device when the pin is not being driven. Additionally, if the device is disabled or if the power supply voltage falls below 1.7 V, both D1 and D2 drain outputs will be in high-impedance OFF-state and disconnected from the internal circuitry to prevent any unwanted power consumption or interference with other connected devices.

#### Spread spectrum clocking (SSC)

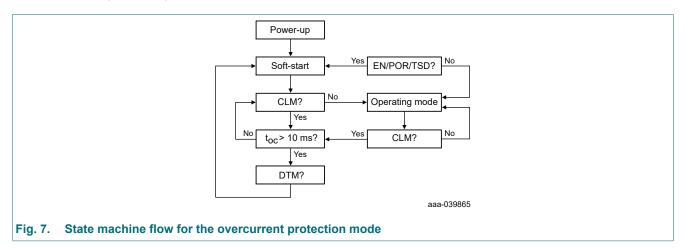
In high current switching power supplies, radiated emissions are a significant issue to consider. To mitigate this, the NXF6501-Q100 employs a technique known as spread spectrum clocking, which involves modulating the internal clock to spread the emitting energy over multiple frequency bins. This feature significantly enhances the emissions performance of the entire power supply block, which relieves the system designer of a major concern in designing an isolated power supply.

#### **Overcurrent protection mode (OPM)**

The NXF6501-Q100 incorporates a protective mechanism against overcurrent, designed to safeguard the system from enduring permanent damage due to excessive current situations. Upon detecting an overcurrent scenario where the current surpasses the predefined threshold ( $I_{th(DET)}$ ) while flowing through the D1 and D2 MOSFET, the NXF6501-Q100 initiates its current limit mode (CLM). This mode regulates the pulse width of the D1 and D2 to reduce the average current passing through them, thus mitigating the risk of damage.

Once the overcurrent condition subsides, the NXF6501-Q100 seamlessly returns to its normal operating mode. However, if the overcurrent persists beyond 10 milliseconds ( $t_{oc}$ ), the NXF6501-Q100 shifts into dead time mode (DTM). In this mode, both D1 and D2 are deactivated to prevent any harm to the system, or its components caused by the prolonged overcurrent situation.

Following the 10-millisecond dead time, the NXF6501-Q100 initiates a soft start mode before transitioning back into its standard operating mode. Fig. 7 shows the state machine flow for the overcurrent protection mode.



### 9. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	6	V
Vo	output voltage	pin D1, D2	-	17	V
I <sub>O(peak)</sub>	peak output current	pin D1, D2	-	2.4	A
TJ	maximum junction temperature		-55	150	°C
T <sub>stg</sub>	storage temperature		-65	150	°C

### 10. ESD ratings

Table 5. ES	Parameter	Conditions	Value	Unit
V <sub>ESD</sub>	electrostatic discharge voltage	HBM: ANSI/ESDA/JEDEC JS-001 class 3A	±6000	V
		CDM: ANSI/ESDA/JEDEC JS-002 class C3	±1500	V

### 11. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.25	5.5	V
Io	output current	pin D1, D2			
		2.25 V < V <sub>CC</sub> < 2.8 V	-	0.85	А
		2.8 V < V <sub>CC</sub> < 5.5 V	-	1.2	А
T <sub>amb</sub>	ambient temperature		-55	125	°C

### 12. Thermal characteristics

#### Table 7. Thermal information

The thermal data is based on the JEDEC standard high K profile, JESD 51-7. Two-signal, two-plane, four-layer board with 2-oz. Copper. The Copper pad is soldered to the thermal land pattern. Also, correct attachment procedure must be incorporated

Symbol	Parameter	SOT8098-1	Unit
R <sub>0JA</sub>	Junction-to-ambient thermal resistance	130	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	<tbd></tbd>	°C/W
R <sub>θJB</sub>	Junction-to-board thermal resistance	<tbd></tbd>	°C/W
Ψ <sub>JT</sub>	Junction-to-top characterization parameter	10.8	°C/W
Ψ <sub>JB</sub>	Junction-to-board characterization parameter	35.9	°C/W
R <sub>0JC(bottom)</sub>	Junction-to-case(bottom) thermal resistance	N/A	°C/W

### **13. Electrical characteristics**

#### **Table 8. Electrical characteristics**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		T <sub>amb</sub> = -55 °C to +125 °C			
				Typ[1]	Мах		
Supply v	oltage						
I <sub>CC</sub>	supply current	2.8 V < $V_{CC}$ < 5.5 V; $R_L$ = 50 Ω [2]	-	1.56	2.3	mA	
ILI	input leakage current	pins D1, D2; D1, D2 = V <sub>CC</sub>	-	0.1	-	μA	
CLK							
f <sub>startup</sub>	start-up frequency		-	300	-	kHz	
f <sub>SW</sub>	switching frequency	pins D1, D2					
		V <sub>CC</sub> = 3.3 V ±10 %	250	360	550	kHz	
		V <sub>CC</sub> = 5 V ±10 %	300	410	620	kHz	
Output st	tage						
∆t <sub>ON</sub>	average ON time mismatch	mismatch between D1 and D2; $R_L$ = 50 $\Omega$	-	0	-	%	
R <sub>ON</sub>	ON resistance	output switch ON resistance; see Fig. 10					
		V <sub>CC</sub> = 5 V, I <sub>D1</sub> , I <sub>D2</sub> = 1 A	-	0.16	0.2	Ω	
		V <sub>CC</sub> = 2.8 V, I <sub>D1</sub> , I <sub>D2</sub> = 1 A	-	0.19	0.28	Ω	
		V <sub>CC</sub> = 2.25 V, I <sub>D1</sub> , I <sub>D2</sub> = 0.5 A	-	0.21	0.4	Ω	
V <sub>SR</sub>	slew rate voltage	pin D1, D2; R <sub>L</sub> = 50 Ω; see <u>Fig. 10</u>					
			-	155	-	V/µs	
I <sub>SR</sub>	slew rate current	$R_L$ = 5 Ω; see Fig. 11					
			-	63	-	A/µs	
I <sub>th(DET)</sub>	current detect	2.8 V < V <sub>CC</sub> < 5.5V	1.48	2.6	3.71	А	
	threshold	2.25 V < V <sub>CC</sub> < 2.8 V	0.65	1.42	3.51	А	
I <sub>LIM(AV)</sub>	average current limit	2.8 V < V <sub>CC</sub> < 5.5 V	184	404	695	mA	
		2.25 V < V <sub>CC</sub> < 2.8 V	32	224	352	mA	

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 5 V

[2] Does not include load current.

### **14. Dynamic characteristics**

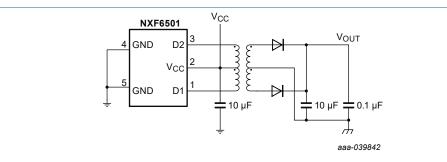
#### Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); For timing diagrams and test circuit see <u>Section 14.1</u>; See also additional graphs in <u>Section 14.2</u>.

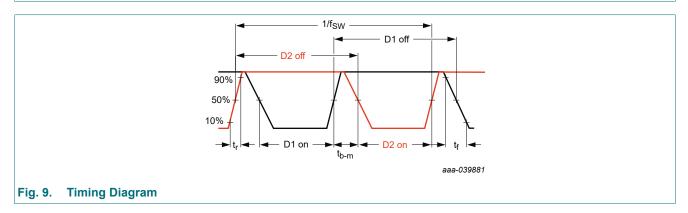
Symbol	Parameter	Conditions	T <sub>amb</sub> =	Unit		
			Min	Typ <mark>[1]</mark>	Max	
Output s	stage					
t <sub>b-m</sub>	break-before-make time	measured as voltage; $R_L = 50 \Omega$ ; see <u>Fig. 10</u>	-	90	-	ns
Soft-sta	rt					
t <sub>SS</sub>	soft-start time	10% to 90% transition time on $V_{OUT}$ with transformer $C_{LOAD}$ = 40 $\mu F;R_L$ = 5 $\Omega$	1	5	9.5	ms
t <sub>SS(delay)</sub>	soft-start time delay	from power up to 90% transition time on V <sub>OUT</sub> with transformer C <sub>LOAD</sub> = 40 $\mu$ F; R <sub>L</sub> = 5 $\Omega$	3.5	8.5	18	ms

[1] Typical values are measured at  $T_J = 25$  °C.

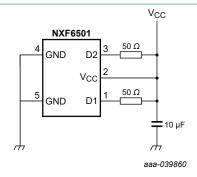
### 14.1. Waveforms and test circuits



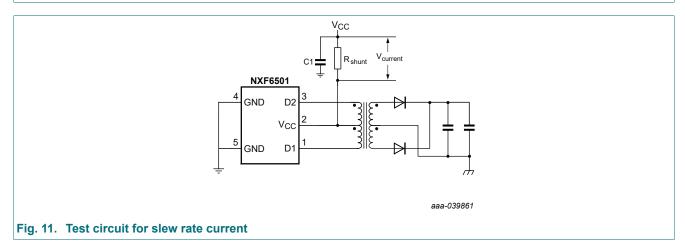
#### Fig. 8. Test circuit for unregulated output (TP1)



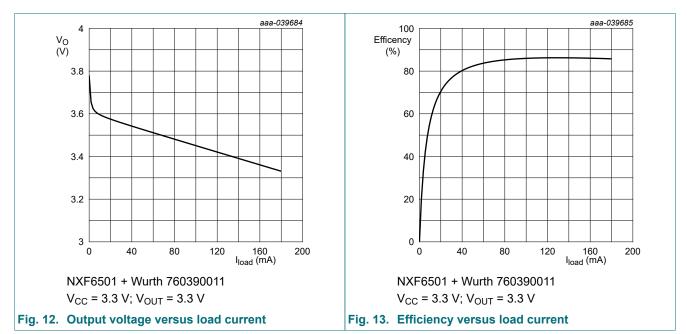
#### Low-noise, 1.2 A transformer driver for isolated power supplies

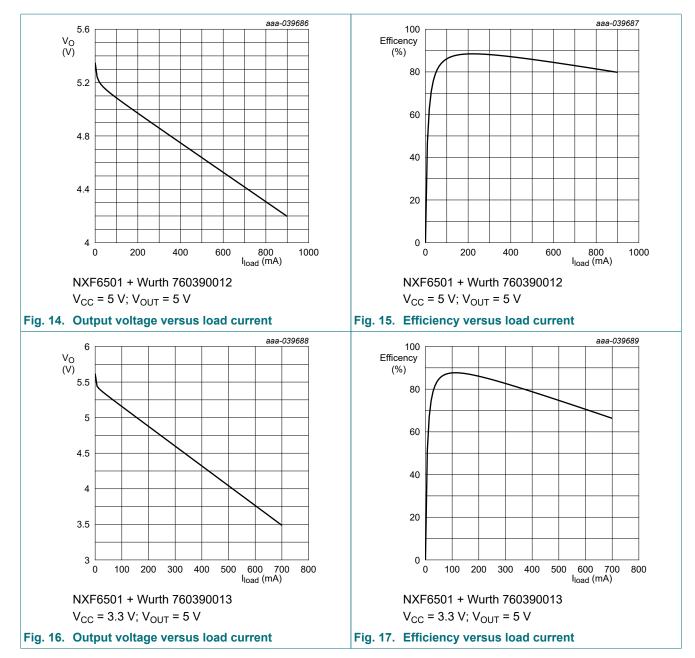


#### Fig. 10. Test circuit for average switching frequency, slew rate voltage, ON resistance and break-before-make time



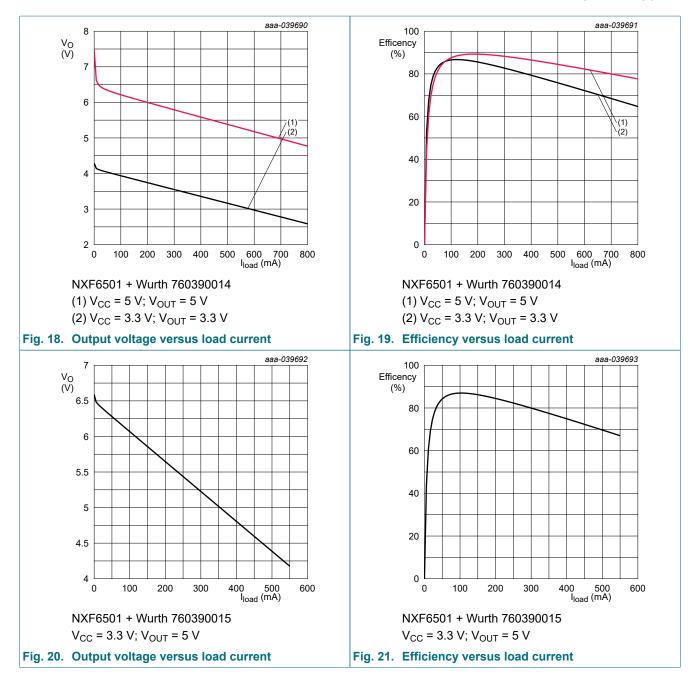
#### 14.2. Typical characteristics NXF6501-Q100





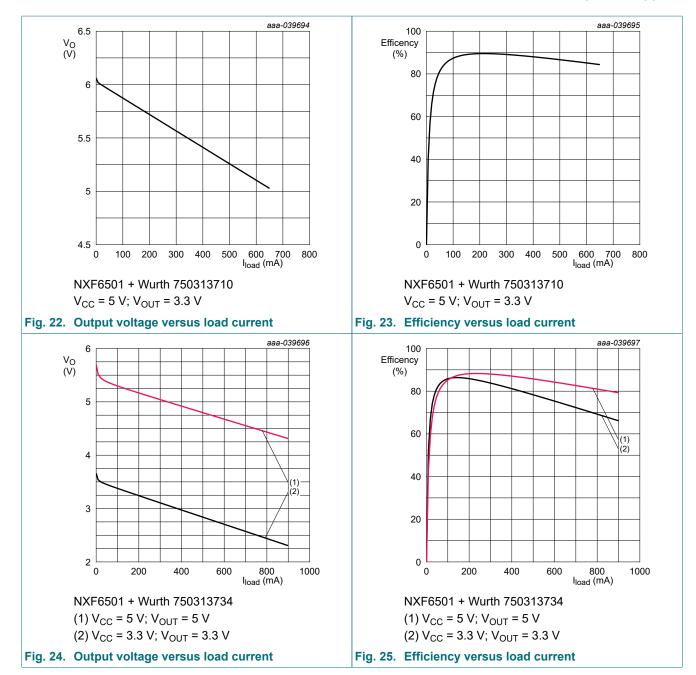
#### Low-noise, 1.2 A transformer driver for isolated power supplies

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#### Low-noise, 1.2 A transformer driver for isolated power supplies

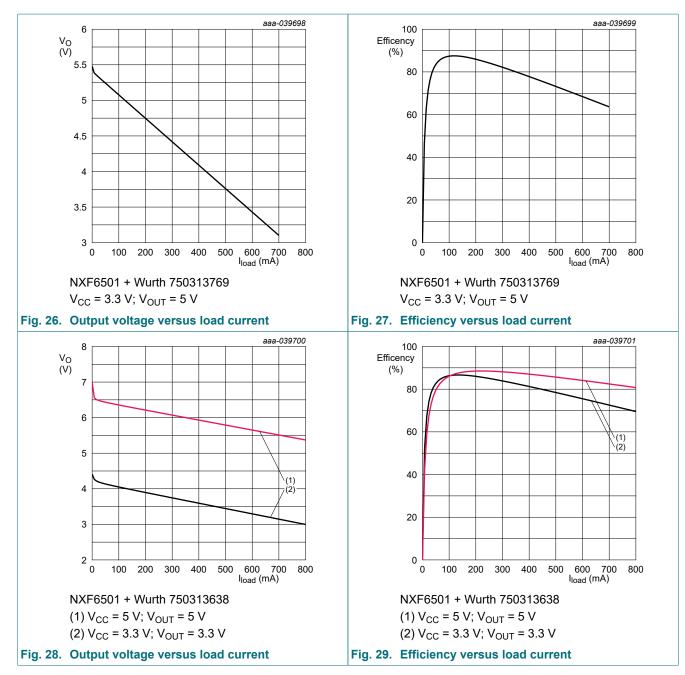
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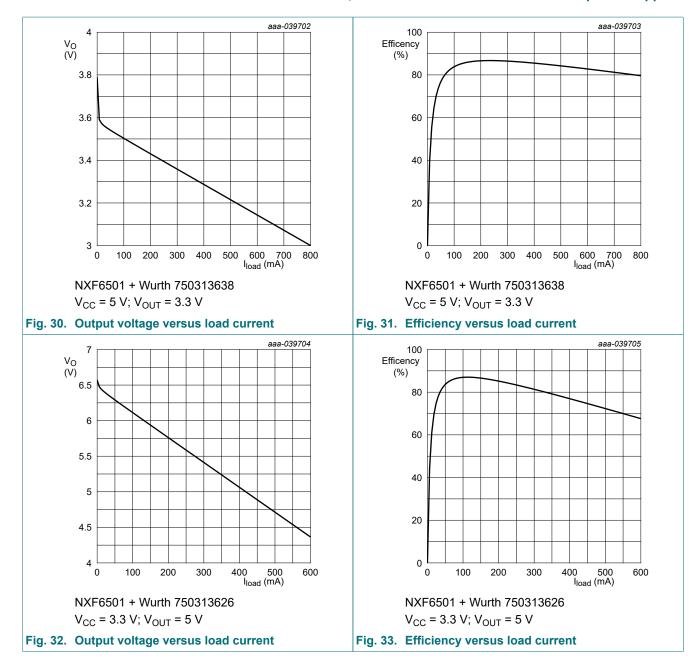


#### Low-noise, 1.2 A transformer driver for isolated power supplies

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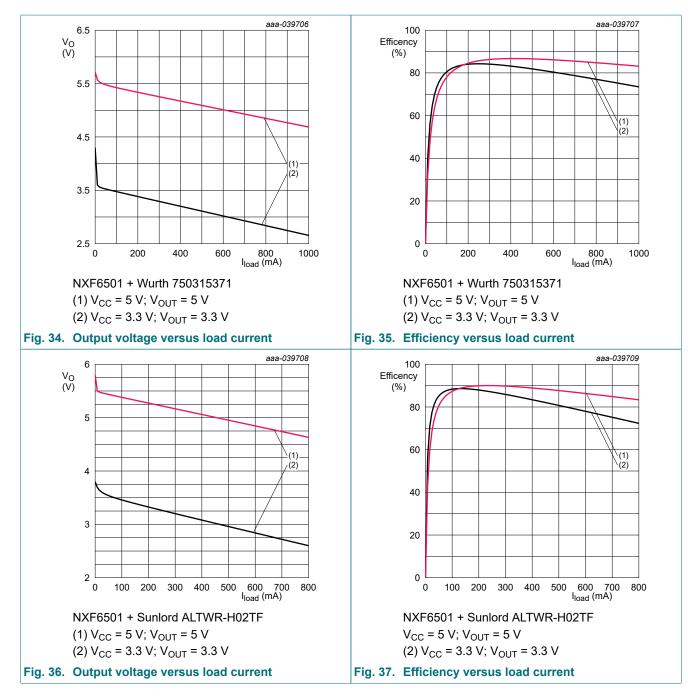


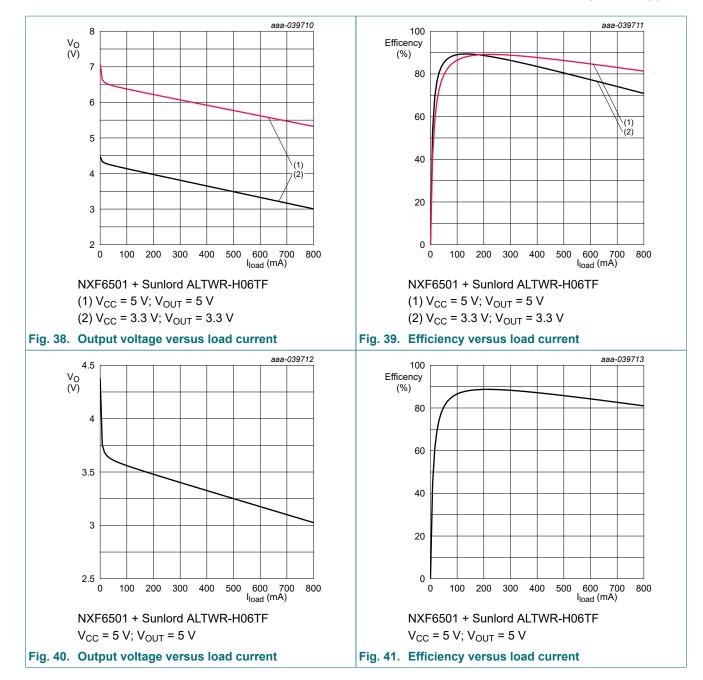


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#### Low-noise, 1.2 A transformer driver for isolated power supplies





#### Low-noise, 1.2 A transformer driver for isolated power supplies

#### Low-noise, 1.2 A transformer driver for isolated power supplies aaa-039714 aaa-039715 7 100 V<sub>O</sub> (V) Efficency (%) 6.5 80 6 60 5.5 40 5 20 4.5 4 0 100 400 500 I<sub>load</sub> (mA) 100 400 500 I<sub>load</sub> (mA) 200 300 200 300 600 0 600 0 NXF6501 + Sunlord ALTWR-H47TF NXF6501 + Sunlord ALTWR-H47TF V<sub>CC</sub> = 5 V; V<sub>OUT</sub> = 3.3 V V<sub>CC</sub> = 5 V; V<sub>OUT</sub> = 3.3 V Fig. 43. Efficiency versus load current Fig. 42. Output voltage versus load current aaa-039716 aaa-039717 100 5 V<sub>O</sub> (V) Efficency (%) 80 4.5 60 4 40 3.5 20 3 0 400 500 I<sub>load</sub> (mA) 0 500 I<sub>load</sub> (mA) 100 100 600 0 200 300 600 0 200 300 400

 $V_{CC}$  = 5 V;  $V_{OUT}$  = 3.3 V Fig. 44. Output voltage versus load current

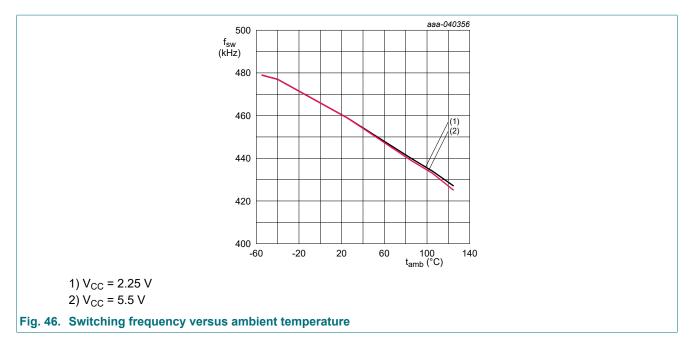
NXF6501 + Sunlord ALTWR-H94TF

V<sub>CC</sub> = 5 V; V<sub>OUT</sub> = 3.3 V Fig. 45. Efficiency versus load current

NXF6501 + Sunlord ALTWR-H94TF

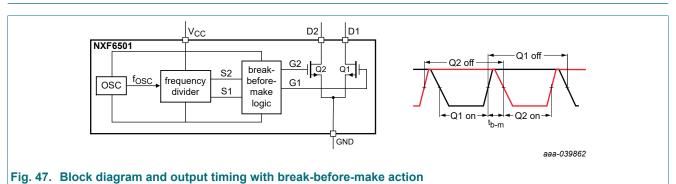
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#### Low-noise, 1.2 A transformer driver for isolated power supplies

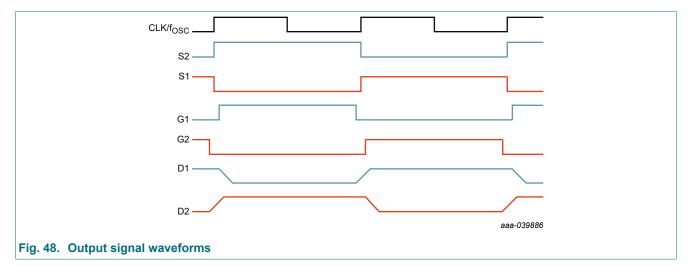


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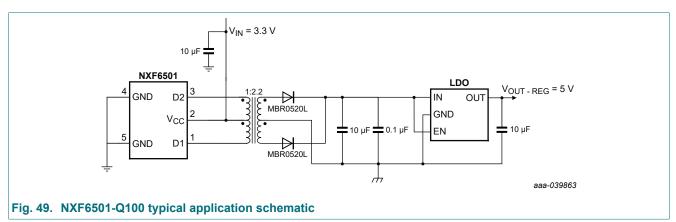
### **15. Application information**



The NXF6501-Q100 is a driver for transformers that has been specifically designed for isolated DC-DC converters with a push-pull topology. It has been created with a focus on being cost-effective and having a small form-factor. The device features an oscillator that is responsible for feeding a gate-drive circuit. The gate-drive circuit consists of a frequency divider and break-before-make  $(t_{b-m})$  logic, which together produce two complementary output signals that switch the output transistors on and off alternately. An asynchronous divider divides the output frequency of the oscillator and provides two complementary output signals, S1 and S2, with a 50% duty cycle. The break-before-make logic inserts a dead-time between the high-pulses of the two signals. The resulting signals, G1 and G2, provide the gatedrive signals for the output transistors must be high-impedance during a short time period before either one of the gates can assume logic high. This brief interval is known as the break-before-make time and is illustrated in Fig. 47.



### **15.1. Typical Application**



#### **Design requirements**

Table 10 Design parameters

For this design example, use the parameters listed in <u>Table 10</u> as design parameters.

Parameters	Values					
Input voltage range	3.3 V ± 3%					
Output voltage	5 V					
Maximum load current	100 mA					

#### **Detailed design procedure**

These guidelines for selecting components are focused on creating a push-pull converter that is efficient and capable of handling high current drive. It's important to note that the output voltage of an unregulated converter drops significantly across a wide range of load currents. **Figure 1** and **Figure 11** illustrate this characteristic curve, which demonstrates that the voltage difference between minimum and maximum loads exceeds the range of a transceiver's supply. To ensure a stable, load-independent power supply while maximizing efficiency, we strongly recommend implementing a low dropout regulator (LDO). **Figure 47** depicts the final converter circuit, and **Figure 2** and **Figure 12** display the measured output voltage and efficiency characteristics for both regulated and unregulated outputs.

#### **Drive capability**

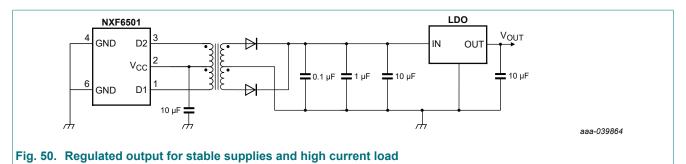
The transformer driver is intended for low-power push-pull converters that have input and output voltages ranging from 2.25 V to 5.5 V. Although it's feasible to create converter designs with higher output voltages, it's important to exercise caution to prevent primary currents from exceeding the device's specified current limits when using higher turns ratios.

#### **Diode selection**

To maximize the voltage output of a converter, it's important for a rectifier diode to have low-forward voltage. In highfrequency switching applications like the NXF6501-Q100, a diode with a short recovery time is also necessary. Schottky diodes fulfill both requirements and are highly recommended for push-pull converter designs. For low-voltage applications with ambient temperatures up to 85 °C, the affordable PMEG3020EP or MBR0520L Schottky rectifier is a great option with a typical forward voltage of 275 mV at 100 mA forward current. If higher output voltages such as ±10 V are needed, the MBR0530 is a better choice with a higher DC blocking voltage of 30 V. However, lab tests have shown that at temperatures above 100 °C, the above Schottky diodes experience a significant increase in leakage currents. This can cause thermal runaway and the output voltage of the rectifier to collapse. To prevent this, use low-leakage Schottky diodes like RB168MM-40 for ambient temperatures exceeding 85 °C.

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#### **Capacitor selection**



The converter circuit shown in Fig. 50 employs multi-layer ceramic chip (MLCC) capacitors as its capacitors. For proper functioning of the high-speed CMOS ICs, a bypass capacitor within 10 nF to 100 nF range is required. The input bulk capacitor, located at the center-tap of the primary, is responsible for supporting high currents during fast switching transients. For minimal ripple, it is recommended to use a 1  $\mu$ F to 10  $\mu$ F capacitor. In a 2-layer PCB design with a dedicated ground plane, this capacitor should be positioned near the primary center-tap to reduce trace inductance. In a 4-layer board design, where low-inductance reference planes are available for ground and VIN, the capacitor can be placed at the entrance of the board. Two parallel vias should be used to ensure low-inductance paths for each connection to a reference plane or to the primary center-tap. To smooth out the output voltage, a bulk capacitor should be placed at the rectifier output. A capacitor with a value of 1  $\mu$ F to 10  $\mu$ F is recommended. Although not always necessary, using a small capacitor with a value of 47 nF to 100 nF at the regulated output for subsequent isolator and transceiver circuitry. The choice of output capacitor depends on the LDO stability requirements, as stated in the data sheet. However, in most cases, a low-ESR ceramic capacitor within the 4.7  $\mu$ F to 10  $\mu$ F range is sufficient to meet these requirements.

#### **Transformer selection**

In order to avoid transformer saturation, the V-t product should exceed the highest V-t product generated by the device. The device's maximum voltage output is determined by adding 10% to the nominal converter input. The primary voltage should not exceed this maximum value for more than half the period of the lowest frequency specified for the input voltage. As a result, the minimum V-t product required for the transformer can be calculated by:

$$V \times t_{min} \ge V_{IN-max} \times \frac{T_{max}}{2} = \frac{V_{IN-max}}{2 \times f_{min}}$$

Assuming a 5 V supply, and considering the values of  $f_{min}$  as 363 kHz for NXF6501-Q100, the minimum V-t products can be obtained by applying the equation above, resulting in:

$$V \times t_{\min} \ge \frac{55V}{2\times 363 \, kHz} = 7.6 \ V \mu s$$
 for NXF6501-Q100.

Low-power center-tapped transformers typically have common V-t values that fall within the range of 22 V $\mu$ s to 150 V $\mu$ s, and they usually have a standard footprint size of 10 mm x 12 mm. However, for transformers specifically intended for PCMCIA applications, V-t values as low as 11 V $\mu$ s can be obtained, and their footprint is significantly smaller at 6 mm x 6 mm. While the device can drive any of these transformers in terms of V-t values, there are other critical factors that must be taken into account before deciding on the most suitable transformer, such as isolation voltage, transformer wattage, and turns ratio.

Turns ratio	V x T Vµs	Isolation V <sub>RMS</sub>	Dimensions (mm)	Application	LDO[1]	Order no.	Manufactuer
1:1.1 ±2%	7	2500	6.73 x 10.05 x 4.19	3.3 V $\rightarrow$ 3.3 V, 100mA, NXF6501; see Fig. 12 and Fig. 13	No	760390011	Wurth
1:1.1 ±2%	11	1		5 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 14 and Fig. 15	1	760390012	Electronics / Midcom
1:1.7 ±2%				3.3 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 16 and Fig. 17		760390013	
1:1.3 ±2%	1			3.3 V $\rightarrow$ 3.3 V, 100mA, NXF6501; see Fig. 18 and Fig. 19	Yes	760390014	
1:1.3 ±2%				5 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 18 and Fig. 19	1	760390014	
1:2.1 ±2%				$3.3 \text{ V} \rightarrow 5 \text{ V}$ , 100mA, NXF6501; see Fig. 20 and Fig. 21	1	760390015	
1.23:1 ±2%				5 V $\rightarrow$ 3.3 V, 100mA, NXF6501; see Fig. 22 and Fig. 23		750313710	
1:1.7 ±2%	8.9		8.3 x 12.6 x 4.1	3.3 V $\rightarrow$ 3.3 V, 1A, NXF6501; see <tbd> and <tbd></tbd></tbd>		750316028	
1:2.1 ±2%	1			3.3 V $\rightarrow$ 5 V, 1A, NXF6501; see <tbd> and <tbd></tbd></tbd>	No	750316029	-
1.3:1 ±2%	10.8			5 V $\rightarrow$ 3.3 V, 1A, NXF6501; see <tbd> and <tbd></tbd></tbd>	]	750316030	
1:1.1 ±2%	8.6			$3.3~\text{V} \rightarrow 3.3~\text{V}$ , 1A, NXF6501; 5 V $\rightarrow$ 5 V, 1A, NXF6501; see Fig. 34 and Fig. 35	]	750315371	
1:1.1 ±2%	11	5000	9.14 x 12.7 x 7.37	3.3 V $\rightarrow$ 3.3 V, 100mA, NXF6501; see Fig. 24 and Fig. 25	]	750313734	
1:1.1 ±2%	]			5 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 24 and Fig. 25		750313734	
1:1.7 ±2%				3.3 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 26 and Fig. 27		750313769	_
1:1.3 ±2%	1			3.3 V $\rightarrow$ 3.3 V, 100mA, NXF6501; 5 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 30 and Fig. 31	Yes	750313638	
1:2.1 ±2%				3.3 V $\rightarrow$ 5 V, 100mA, NXF6501; see Fig. 32 and Fig. 33		750313626	
1.3:1 ±2%				5 V $\rightarrow$ 3.3 V, 100mA, NXF6501; see Fig. 30 and Fig. 31	No	750313638	
1:1.3 ±3%	11	5000	10.4 x 12.2 x 6.1	3.3 V $\rightarrow$ 3.3 V, 300mA, NXF6501; 5 V $\rightarrow$ 5 V, 300mA, NXF6501	No	HCT-SM-1.3-8-2	Bourns
1:1.1 ±2%	9.2	2500	7.01 x 11 x 4.19	3.3 V $\rightarrow$ 3.3 V, 150mA, NXF6501; 5 V $\rightarrow$ 5 V, 150mA, NXF6501	No	EPC3668G-LF	PCA Electronics
3:4 ±5%	10	5000	12.5 x 9.2 x 7.6	3.3 V $\rightarrow$ 3.3 V, 600mA, NXF6501; see Fig. 38 and Fig. 39	Yes	ALTWR-H06TF	SunLord
1:2 ±5%	11	5000	12.5 x 9.2 x 7.6	3.3 V $\rightarrow$ 5 V, 600mA, NXF6501; see Fig. 42 and Fig. 43	Yes	ALTWR-H47TF ALTWR-H94TF	
11:9 ±5%	16	5000	12.5 x 9.2 x 7.6	5 V $\rightarrow$ 3.3 V, 600mA, NXF6501; see Fig. 44 and Fig. 45	Yes		
3:4 ±5%	10	5000	12.5 x 9.2 x 7.6	5 V $\rightarrow$ 5 V, 600mA, NXF65051; see Fig. 38 and Fig. 39	Yes	ALTWR-H06TF	1
8:9 ±5%	11	5000	12.5 x 9.2 x 7.6	3.3 V $\rightarrow$ 3.3 V, 600mA, NXF6501; see Fig. 36 and Fig. 37	No	ALTWR-H02TF	1
1:1.55 ±5%	13	5000	12.5 x 9.2 x 7.6	$3.3 \text{ V} \rightarrow 5 \text{ V}, 600 \text{mA}, \text{NXF6501}$	No	ALTWR-H61TF	]

#### Table 11. Recommended isolation transformers optimized for the NXF6501-Q100

#### Low-noise, 1.2 A transformer driver for isolated power supplies

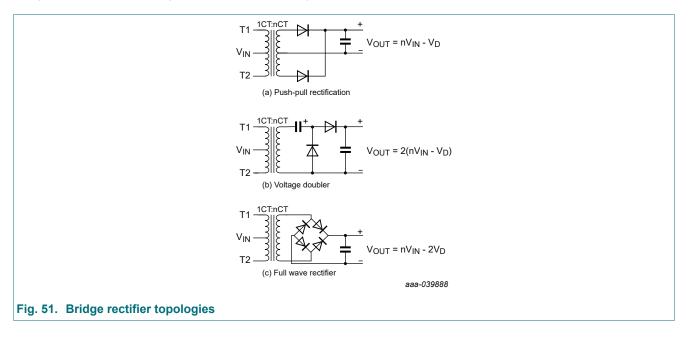
		Isolation V <sub>RMS</sub>	Dimensions (mm)	Application	LDO[1]	Order no.	Manufactuer
3:4 ±5%	10	5000	12.5 x 9.2 x 7.6	5 V $\rightarrow$ 3.3 V, 600mA, NXF6501; see Fig. 40 and Fig. 41	No	ALTWR-H06TF	
8:9 ±5%	11	5000	12.5 x 9.2 x 7.6	$5~\text{V}\rightarrow 5~\text{V},$ , 600mA, NXF6501; see Fig. 36 and Fig. 37	No	ALTWR-H02TF	
1:1.5 ±3%	34.4	2500	10 x 12.07 x 5.97	$3.3 \text{ V} \rightarrow 3.3 \text{ V}$ , 1A, NXF6501; 5 V $\rightarrow$ 5 V, 1A, NXF6501	Yes	DA2303-AL	Coilcraft
1:2.2 ±3%	21.5	2500	10 x 12.07 x 5.97	$3.3 \text{ V} \rightarrow 5 \text{ V}, 1\text{A}, \text{NXF6501}$		DA2304-AL	

[1] For configurations with LDO, a higher voltage than the required output voltage is generated, to allow for LDO drop-out.

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#### Higher output voltage designs

The NXF6501-Q100 can produce high output voltages of up to 30 V or bipolar outputs of up to  $\pm 15$  V can be driven by the device. However, if commercially available center-tapped transformers with low turns ratios between 0.8 to 5 are used, different rectifier topologies must be employed to achieve high output voltages. Fig. 51 illustrates some of these topologies along with their corresponding open-circuit output voltages.



#### 15.2. Power supply recommendations

The equipment is intended to function within a range of input voltage supply between 2.5 V and 5 V nominal, which requires regulation within  $\pm 10$  %. When the input supply is situated farther than a few inches from the device, it is advisable to connect a 0.1 µF by-pass capacitor as near as possible to the device's V<sub>CC</sub> pin, and a 10 µF capacitor near the transformer center-tap pin.

#### 15.3. Layout guidelines

To ensure proper functioning, the V<sub>IN</sub> pin requires a low-ESR ceramic bypass-capacitor, with a recommended capacitor value ranging from 1  $\mu$ F to 10  $\mu$ F. The capacitor should have a voltage rating of at least 10 V and use X5R or X7R dielectric material.

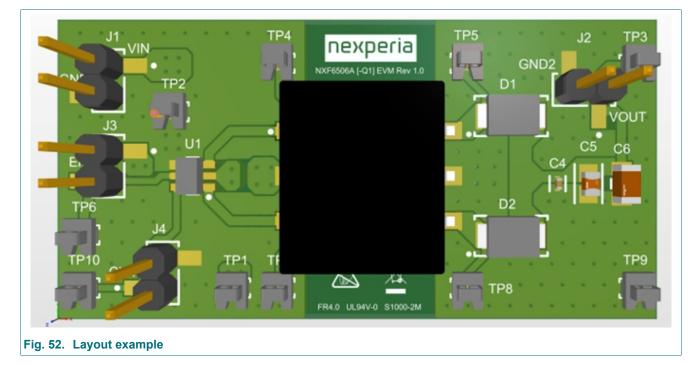
The optimal placement for the capacitor is closest to the  $V_{IN}$  and GND pins at the board entrance, minimizing the loop area formed by the bypass-capacitor connection, the  $V_{IN}$  terminal, and the GND pin, as demonstrated in Fig. 52 of the PCB layout example.

Furthermore, the connections between the device's D1 and D2 pins and the transformer primary endings, and the connection of the device  $V_{CC}$  pin and the transformer center-tap should be as close as possible to minimize trace inductance.

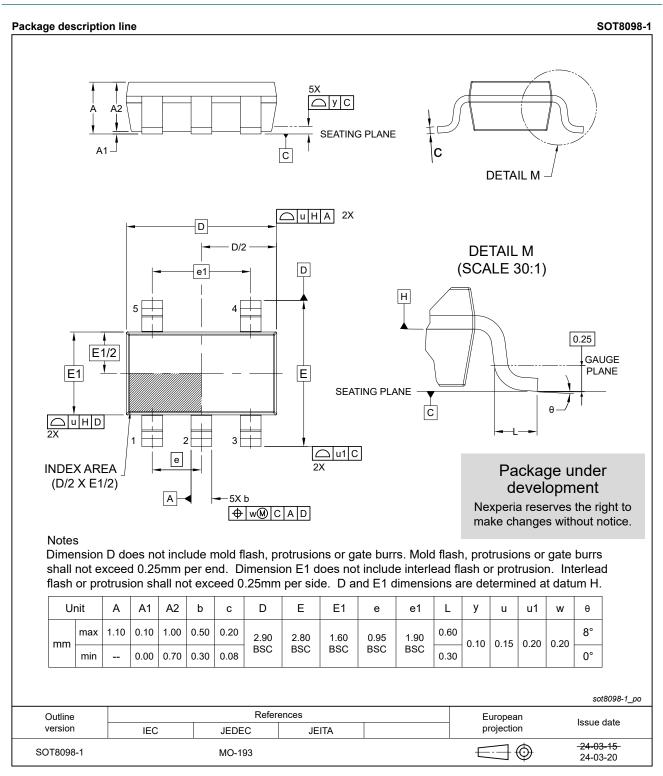
The device V<sub>CC</sub> pin and transformer center-tap should be buffered to ground using a low-ESR ceramic bypass-capacitor with a recommended capacitor value ranging from 1  $\mu$ F to 10  $\mu$ F. The capacitor should have a voltage rating of at least 16 V and use X5R or X7R dielectric material.

Additionally, the device GND pins must be tied to the PCB ground plane using at least two vias to minimize inductance. The ground connections of the capacitors and the ground plane should also use at least two vias for the same reason.

Finally, the V<sub>OUT</sub> pin also requires buffering to ISO-Ground with a low-ESR ceramic bypass-capacitor, with a recommended capacitor value ranging from 1  $\mu$ F to 10  $\mu$ F. The capacitor should have a voltage rating of at least 16 V and use X5R or X7R dielectric material.



### **16.** Package outline





### 17. Abbreviations

Acronym	Description
CDM	Charged-Device Model
CMOS	Complementary Metal Oxide Semiconductor
EMI	Electromagnetic Interference
MOSFET	Metal-Oxide-Semiconductor Field-Effect Transistor
UVLO	Undervoltage Lockout
SSC	Spread Spectrum Clocking
НВМ	Human Body Model
ESD	ElectroStatic Discharge
MLCC	Multi-Layer Ceramic Capacitors
tbd	To Be Determined

### 18. Revision history

Table 13. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
NXF6501_Q100 v.1	20240624	Objective data sheet	-	-			

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### **19. Legal information**

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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